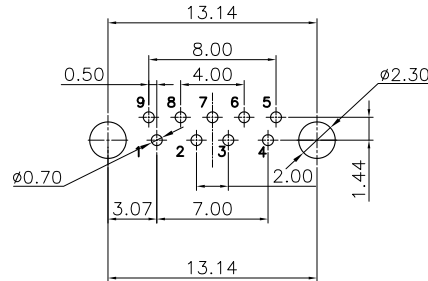
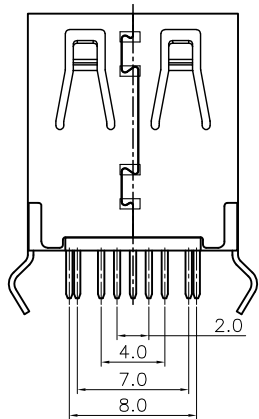
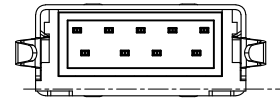
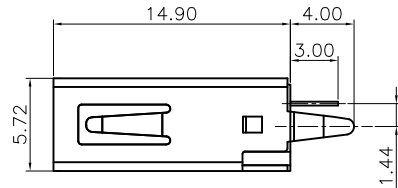
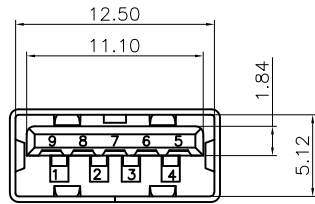
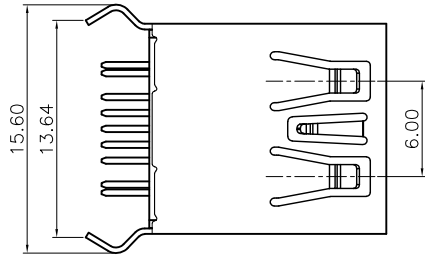


RoHScompliant



TOLERANCE: ± 0.05 ,
RECOMMENDED PCB LAYOUT
(TOP VIEW)

NOTES:

1.MATERIAL:

- 1.1 HOUSING: HIGH TEMPERATURE THERAL PLASTIC.
- 1.2 SPRING CONTACT: COPPER ALLOY.
- 1.3 FLAT CONTACT; COPPER ALLOY
- 1.4 SHELL : COPPER ALLOY.
- 1.5 COVER: HIGH TEMPERATURE THERAL PLASTIC.

2.FINISH:

- 2.1 CONTACT: (SEE P/N.), [50 μ] MIN. NICKEL UNDERPLATING OVER ALL.
- 2.2 SHELL: [50 μ] MIN. SOLDERABILITY NICKEL UNDERPLATING OVER ALL.

3.PART NUMBER DESCRIPTION :

R UF-C057- L 09 W1 - X

RoHS

HOUSING COLOR:
B-BLACK
L-BLUE

PACKING:
R-TAPE REEL
T-TRAY
E-TUBE

PLATING:
W1-[1 μ]GOLD CONTACT AREA
[100 μ]TIN SOLDER AREA
W2-[5 μ]GOLD CONTACT AREA
[100 μ]TIN SOLDER AREA

| PIN NO. | PIN 1 | PIN 2 | PIN 3 | PIN 4 |
|-------------|----------------------|-------|-------|-------|
| SLGNAL NAME | V BUS | D- | D+ | GND |
| REMARK | USB 2.0 CONTACT PINS | | | |

| PIN NO. | PIN 5 | PIN 6 | PIN 7 | PIN 8 | PIN 9 |
|-------------|----------------------|------------|-----------|------------|------------|
| SLGNAL NAME | STDA_SSRX- | STDA_SSRX+ | GND_DRAIN | STDA_SSTX- | STDA_SSTX+ |
| REMARK | USB 3.0 CONTACT PINS | | | | |

| REV | ECN NO | DESCRIPTION | DATE | SIGNATURE | PROJECT | DRAWING NO | REV | A0 | TITLE |
|-----|--------|-------------|------------|-----------|---------|------------|-----|----|---|
| A0 | | NEW DESIGN | 2016/07/22 | | | | | | USB 3.0, A TYPE, V/T,DIP,H=14.9mm,CONNECTOR. |

X-SHUN 东莞市祥舜电子科技有限公司
DONGGUAN X-SHUN ELECTRONICTECHNOLOGY CO., LTD
TEL:+86 769 81885389 FAX:+86 769 81887859
E-Mail:sales@x-shun.com Http:www.x-shun.com

PART NO. RUF-C057-L09W1-X